Note: This document is an abridged translation of the Japanese original for reference purposes only. In the event of any inconsistency between this translated document and the Japanese original, the Japanese original shall prevail

September 27, 2024

Company name: RS Technologies Co., Ltd.
Name of representative: Nagayoshi Ho,
(Securities code: 3445; Prime Market)
Inquiries: Katsuya Tabuchi,
Manager of Corporate Planning
(Telephone: +81-3-5709-7685)

Notice of Capital Investment Plan in Wafer Reclaimed Business

At the Board of Directors held on September 26, 2024, RS Technologies decided to invest in Sanbongi Plant in Miyagi Prefecture, which is a mother plant of the wafer reclaimed business. Details are as follows.

1.Reason for Capital Investment

Our wafer reclaimed business has been engaged in reclaiming test wafers used in the semiconductor manufacturing process and our customers are mainly semiconductor manufacturers in Japan and overseas.

Considering the acceleration of the semiconductor market growth in recent years and the continuation of growing demand, we plan to increase production capacity at our Sanbongi Plant. We are going to install new facilities, machinery and equipment at the Plant 7. The plant 7 used to reclaim test wafers. However, after we consolidated production in the Plant 8 which is our main plant in Sanbongi, the operation at the Plant 7 had discontinued. By executing the investment plan, we will reactivate the Plant 7 in order to increase our production capacity and start mass production scheduled from FY2027.

RS Technologies has decided to make this decision based on the belief that this capital investments will contribute to our customers, the semiconductor market and the development of our company’s business performance.
Through this capital investment, we will be able to increase our global market share in reclaimed wafers market.

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2.Outline of Capital Investment

(1) Address	**The Plant 7**, 26-2 Otonashi Azayamazaki, Osaki, Miyagi Prefecture
(2) Production Increase	FY 2027 Monthly production: +100,000 wafers FY 2028 Monthly production: +40,000 wafers FY 2029 Monthly production: +30,000 wafers
(3) Schedule of mass production	The first quarter of FY 2027
(4) Expected amount of investment	¥15,142,000,000 (total amount for FY27, FY28, FY29)
(5) Method of financing	Equity and borrowings

*The capital investment plan in FY 2028 and beyond may be adjusted, depending on market conditions.

3 Future Outlook

The capital investment will have no impact on the consolidated financial results for FY2024. The impact on the financial results for the following fiscal year and beyond will be disclosed when it is appropriate.

(Reference: Layout of Plant 7)

